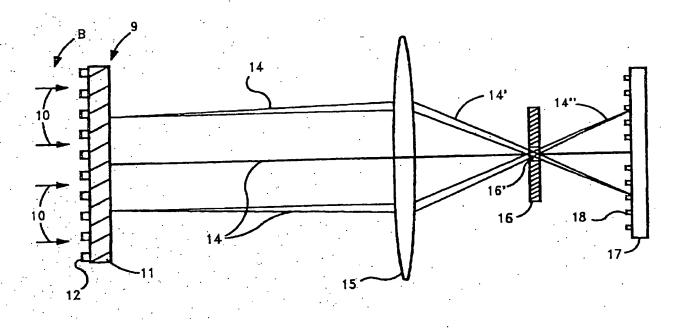
Figure 1



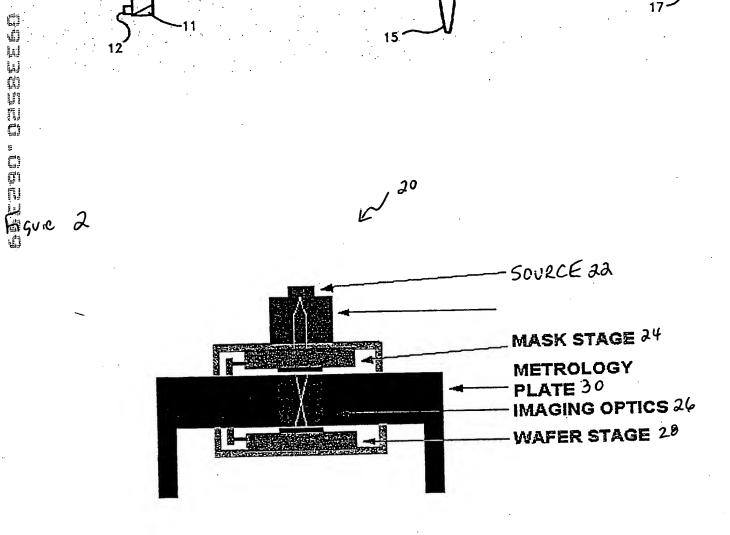


Figure 3

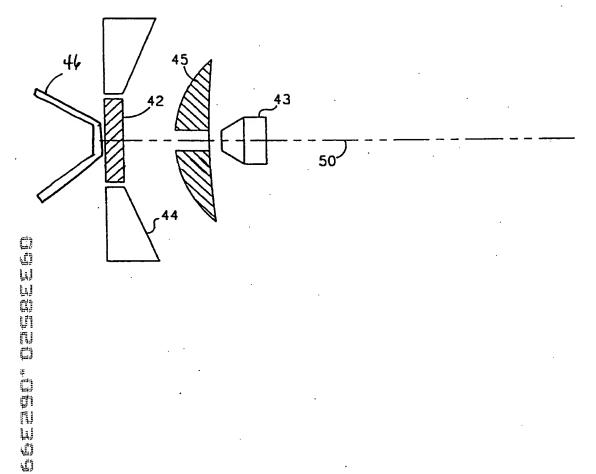


Figure 5 emissive layer 116 buffer Substrate 112 46 100 Figure 4 prepare substrate surface for deposition 200 deposit on substrate 300 deposit emissive layer buffer.

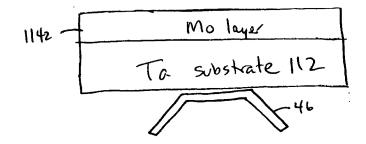
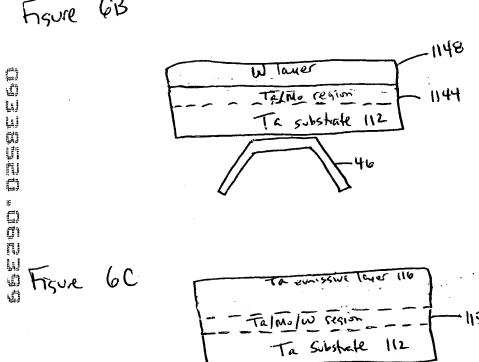


Figure 6B



W) IIO

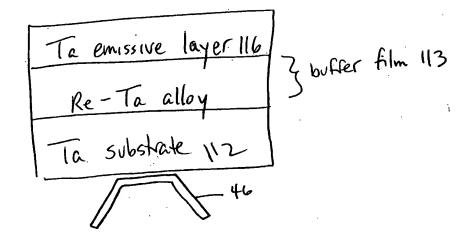


Figure QA

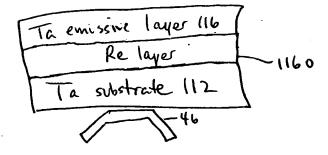


Figure BB

Ta emissive layer 11b

Ta-Re alloy

Ta substate 112